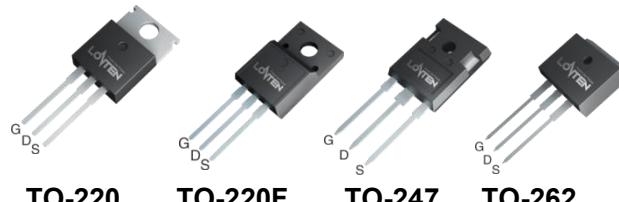
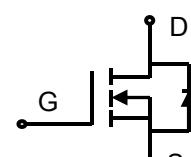


Lonten N-channel 600V, 20A Power MOSFET

Description	Product Summary
The Power MOSFET is fabricated using the advanced planer VDMOS technology. The resulting device has low conduction resistance, superior switching performance and high avalanche energy.	V_{DSS} 600V I_D 20A $R_{DS(on),max}$ 0.45Ω $Q_{g,typ}$ 63.7 nC
Features	 <p>TO-220 TO-220F TO-247 TO-262</p>
Applications	<ul style="list-style-type: none"> ◆ Low $R_{DS(on)}$ ◆ Low gate charge (typ. $Q_g = 63.7$ nC) ◆ 100% UIS tested ◆ RoHS compliant  <p>N-Channel MOSFET</p>
	

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	600	V
Continuous drain current ($T_c = 25^\circ\text{C}$) ($T_c = 100^\circ\text{C}$)	I_D	20 12.5	A A
Pulsed drain current ¹⁾	I_{DM}	80	A
Gate-Source voltage	V_{GSS}	± 30	V
Avalanche energy, single pulse ²⁾	E_{AS}	845	mJ
Peak diode recovery dv/dt ³⁾	dv/dt	5	V/ns
Power Dissipation TO-220F ($T_c = 25^\circ\text{C}$) Derate above 25°C	P_D	45 0.36	W W/ $^\circ\text{C}$
Power Dissipation TO-247/TO-220 ($T_c = 25^\circ\text{C}$) Derate above 25°C		250 2	W W/ $^\circ\text{C}$
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$
Continuous diode forward current	I_S	20	A
Diode pulse current	$I_{S,pulse}$	80	A

Thermal Characteristics

Parameter	Symbol	Value		Unit
		TO-220F	TO-247/TO-220	
Thermal resistance, Junction-to-case	$R_{\theta JC}$	2.78	0.5	$^\circ\text{C}/\text{W}$
Thermal resistance, Junction-to-ambient	$R_{\theta JA}$	62.5	40	$^\circ\text{C}/\text{W}$

Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube	Units/Reel
LNB20N60	TO-247	LNB20N60	30	
LND20N60	TO-220F	LND20N60	50	
LNC20N60	TO-220	LNC20N60	50	
LNF20N60	TO-262	LNF20N60	50	

Electrical Characteristics

T_c = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =0.25 mA	600	-	-	V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =0.25 mA	2	-	4	V
Drain cut-off current	I _{DSS}	V _{DS} =600 V, V _{GS} =0 V, T _j = 25°C T _j = 125°C	-	-	1 100	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =30 V, V _{DS} =0 V	-	-	100	nA
Gate leakage current, Reverse	I _{GSRR}	V _{GS} =-30 V, V _{DS} =0 V	-	-	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =10A	-	0.34	0.45	Ω
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	-	2960	-	pF
Output capacitance	C _{oss}		-	263	-	
Reverse transfer capacitance	C _{rss}		-	18	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 300 V, I _D = 20A R _G = 10 Ω, V _{GS} =15 V	-	17.0	-	ns
Rise time	t _r		-	46.1	-	
Turn-off delay time	t _{d(off)}		-	108.5	-	
Fall time	t _f		-	19	-	
Gate charge characteristics						
Gate to source charge	Q _{gs}	V _{DD} =480 V, I _D =20 A, V _{GS} =0 to 10 V	-	15.6	-	nC
Gate to drain charge	Q _{gd}		-	25.2	-	
Gate charge total	Q _g		-	63.7	-	
Gate plateau voltage	V _{plateau}		-	5	-	
Reverse diode characteristics						
Diode forward voltage	V _{SD}	V _{GS} =0 V, I _F =20A	-	-	1.5	V
Reverse recovery time	t _{rr}	V _R =300 V, I _F =20A dI _F /dt=100 A/μs	-	448.8	-	ns
Reverse recovery charge	Q _{rr}		-	6.5	-	
Peak reverse recovery current	I _{rrm}		-	29.1	-	

Notes:

1. Pulse width limited by maximum junction temperature.
2. L=10mH, I_{AS} = 13A, Starting T_j= 25°C.
3. I_{SD} = 20A, di/dt≤100A/us, V_{DD}≤BV_{DS}, Starting T_j= 25°C.

Electrical Characteristics Diagrams

Figure 1. Typical Output Characteristics

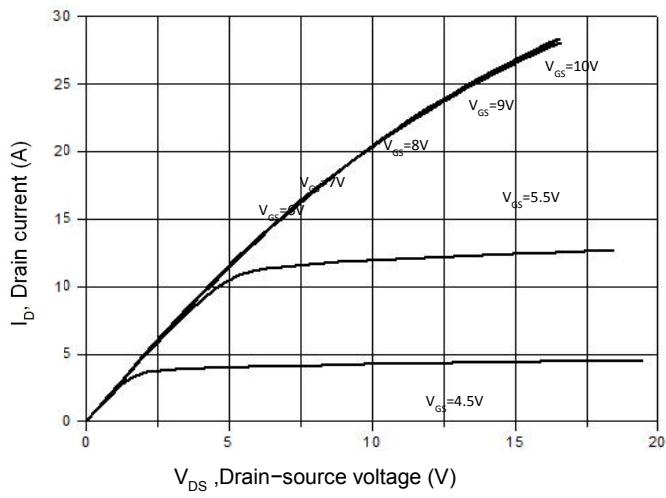


Figure 3. On-Resistance Variation vs. Drain Current

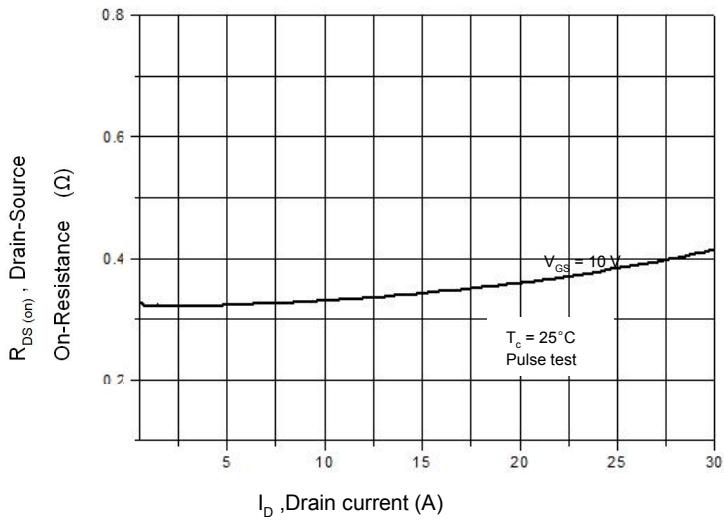


Figure 5. Breakdown Voltage vs. Temperature

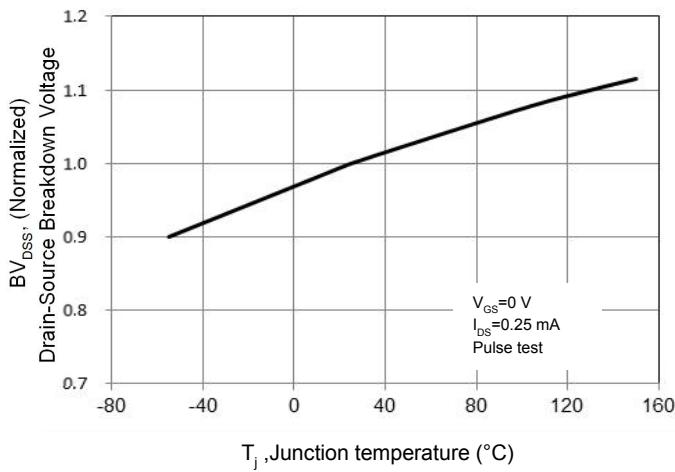


Figure 2. Transfer Characteristics

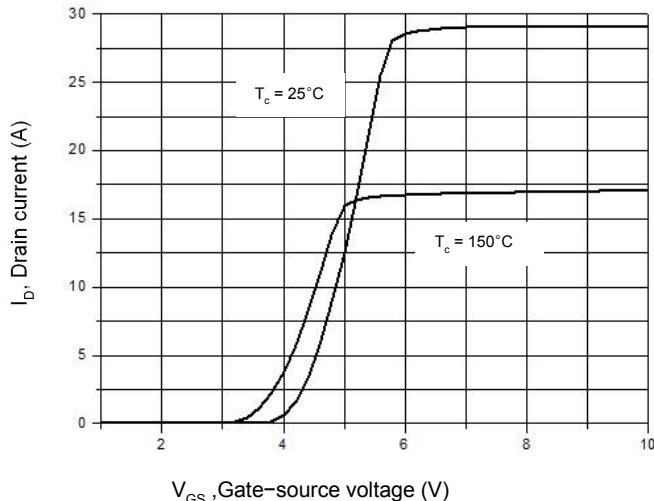


Figure 4. Threshold Voltage vs. Temperature

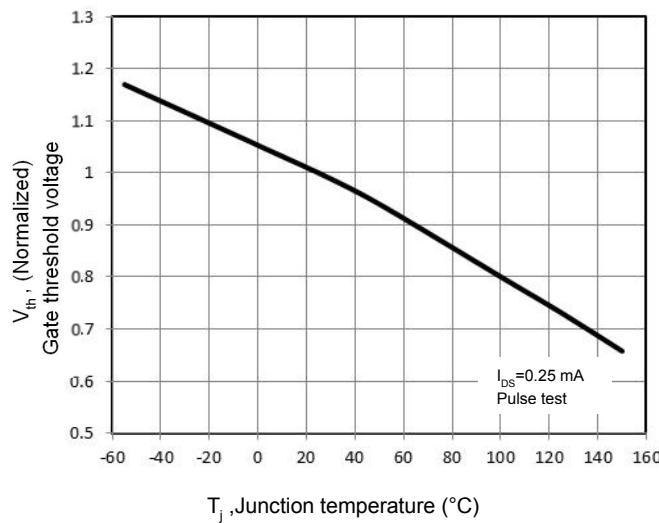


Figure 6. On-Resistance vs. Temperature

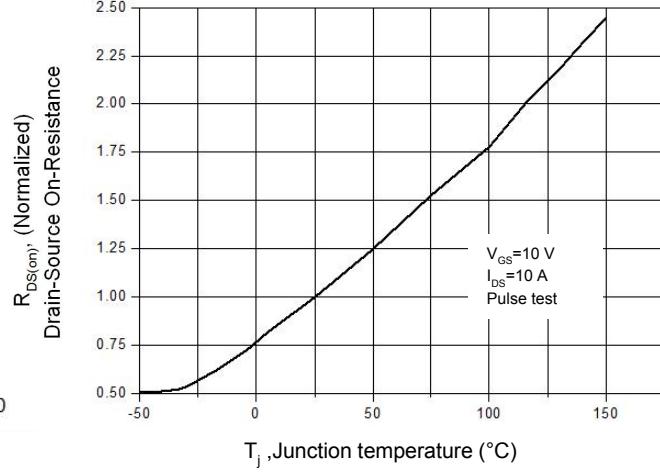


Figure 7. Capacitance Characteristics

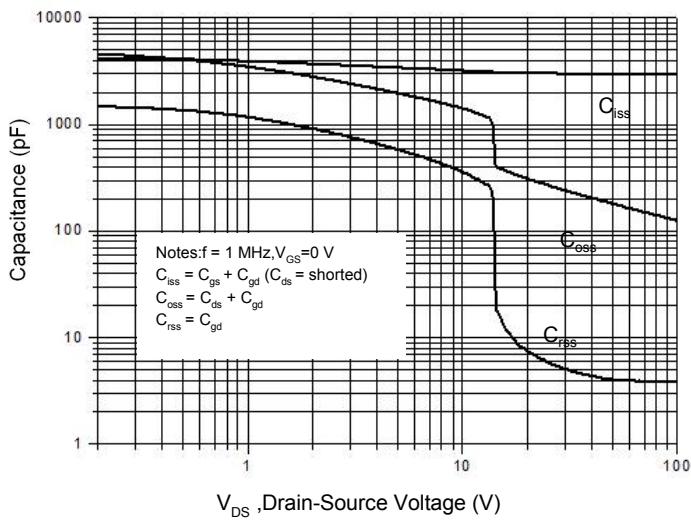


Figure 9. Maximum Safe Operating Area

TO-220F

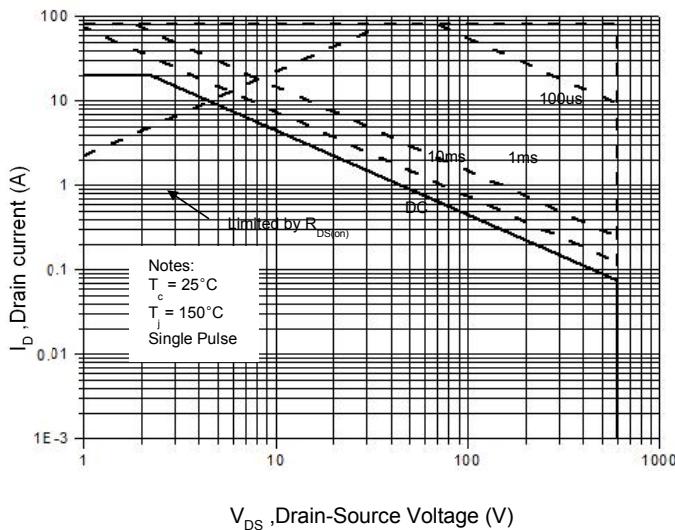


Figure 11. Power Dissipation vs. Temperature

TO-220F

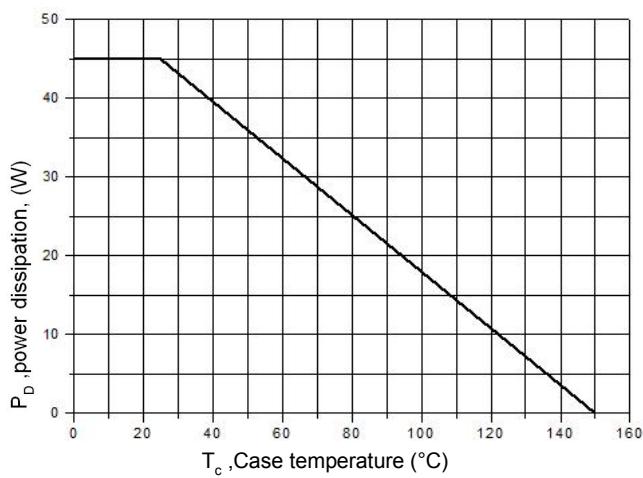


Figure 8. Gate Charge Characteristics

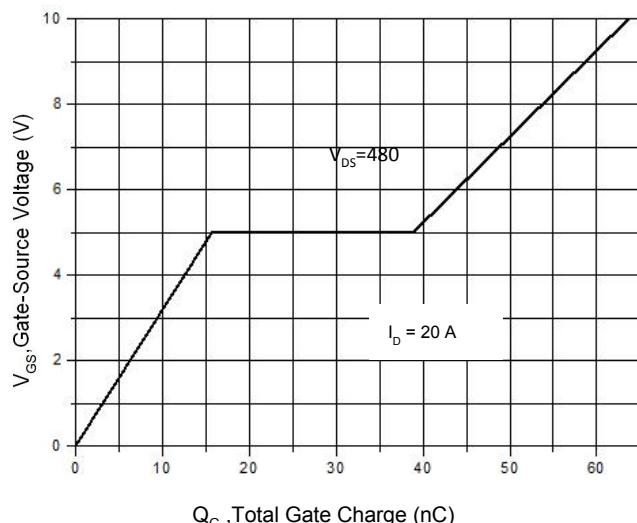


Figure 10. Maximum Safe Operating Area

TO-247/TO-220

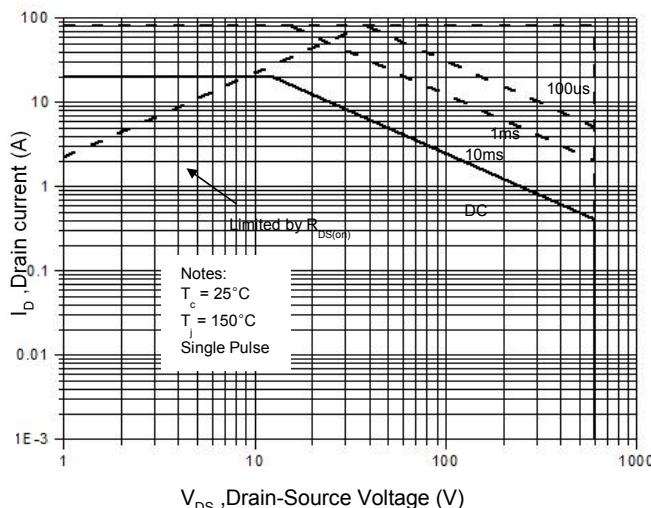


Figure 12. Power Dissipation vs. Temperature

TO-247/TO-220

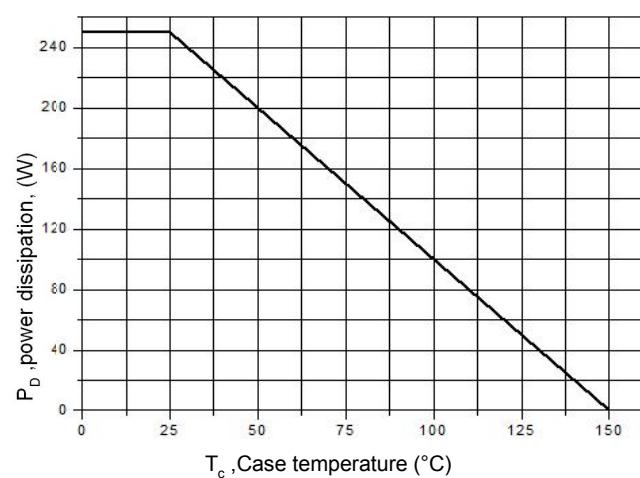


Figure 13. Continuous Drain Current vs. Temperature

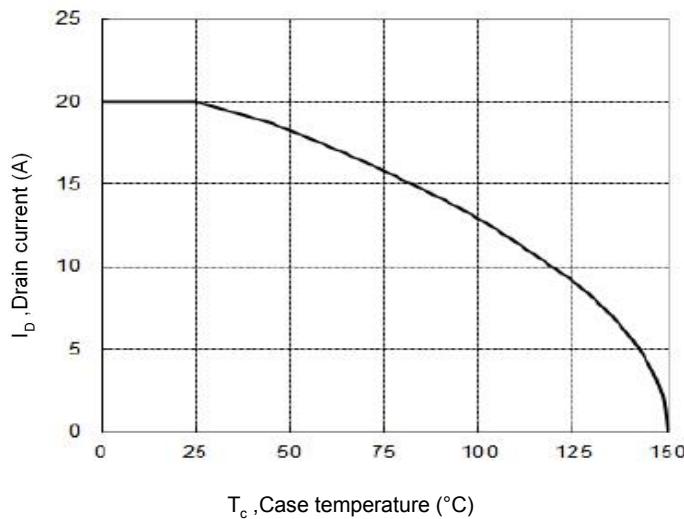


Figure 14. Body Diode Transfer Characteristics

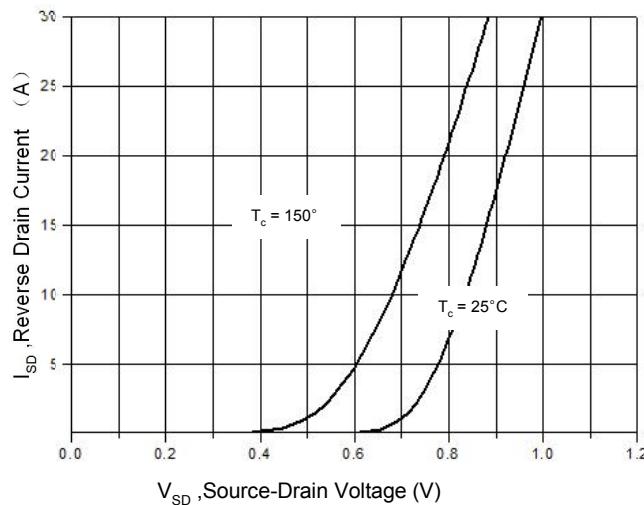


Figure 15 Transient Thermal Impedance, Junction to Case, TO-220F

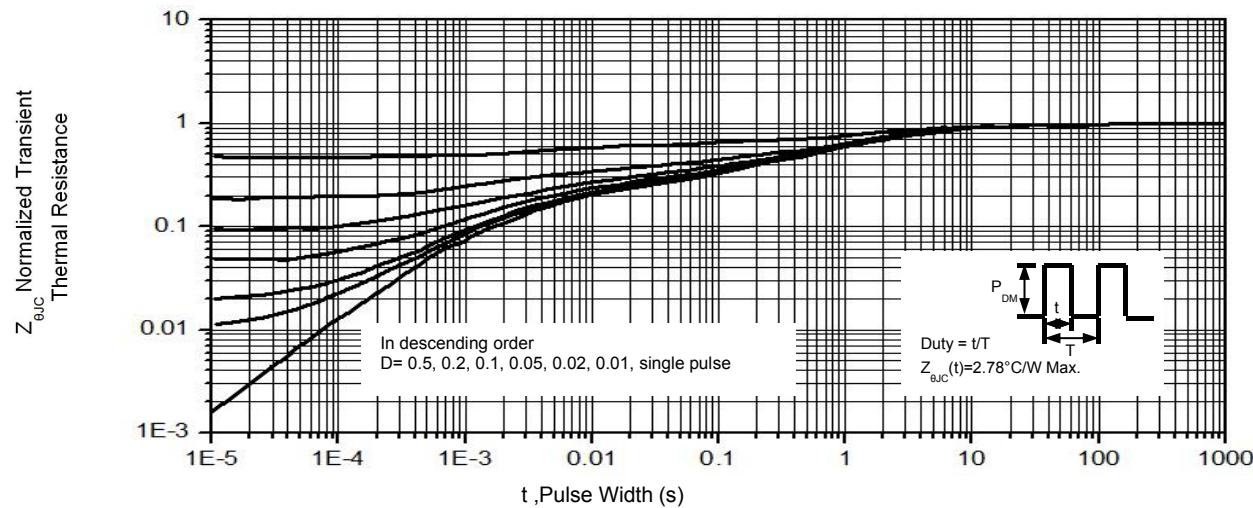
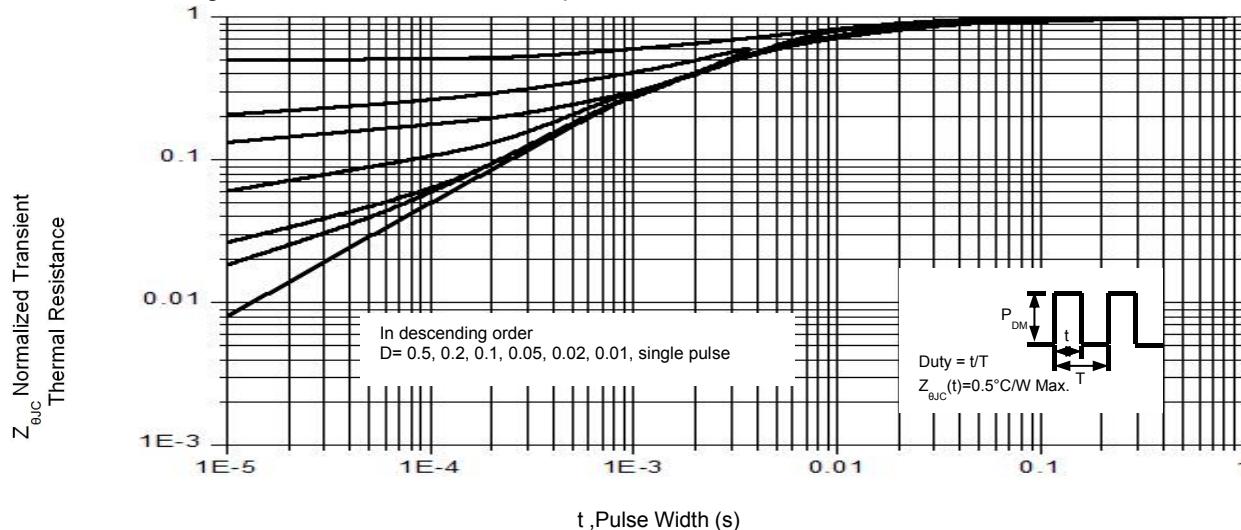
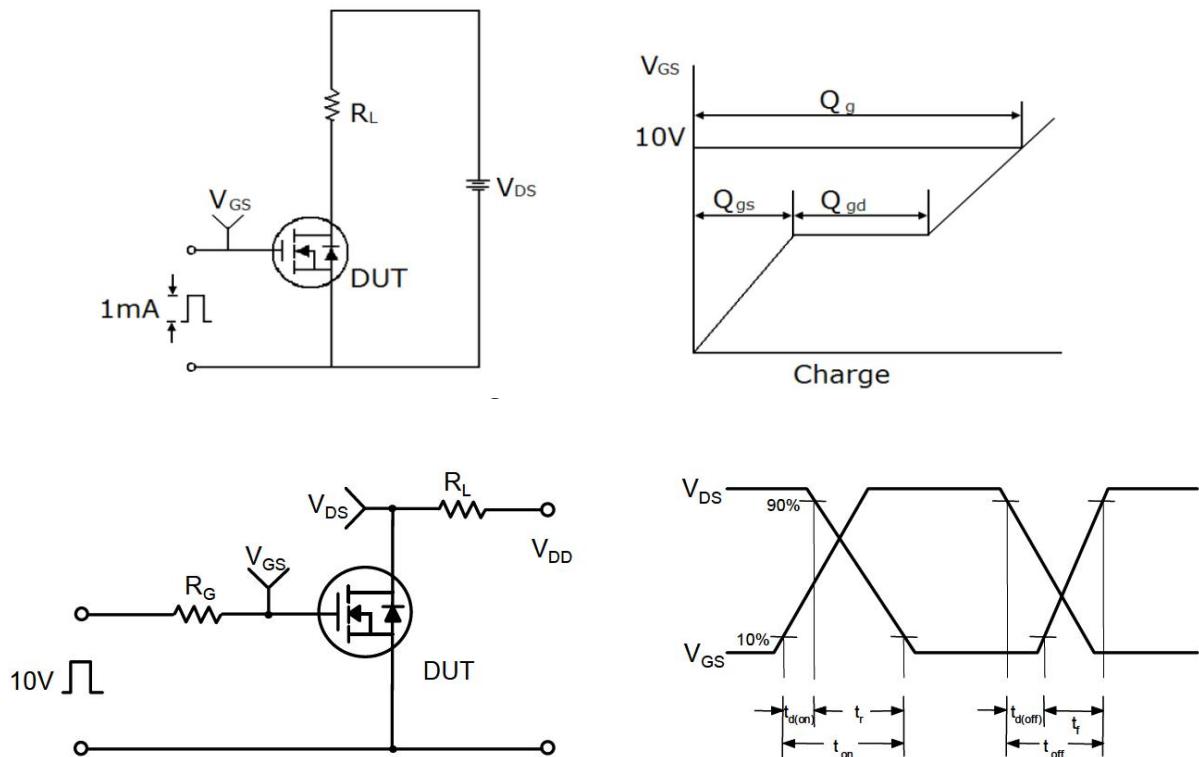


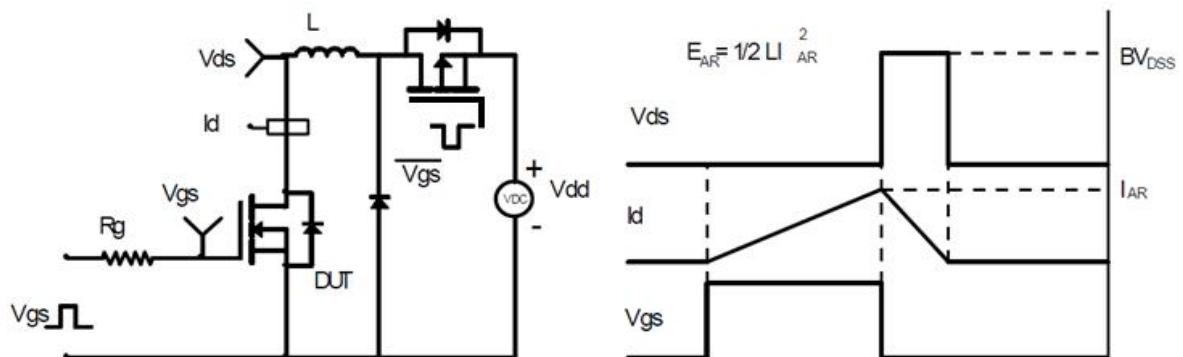
Figure 16. Transient Thermal Impedance, Junction to Case, TO-247/TO-220



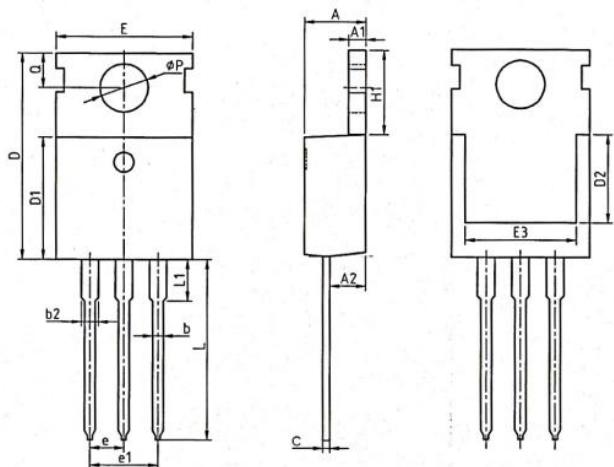
Gate Charge Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveforms

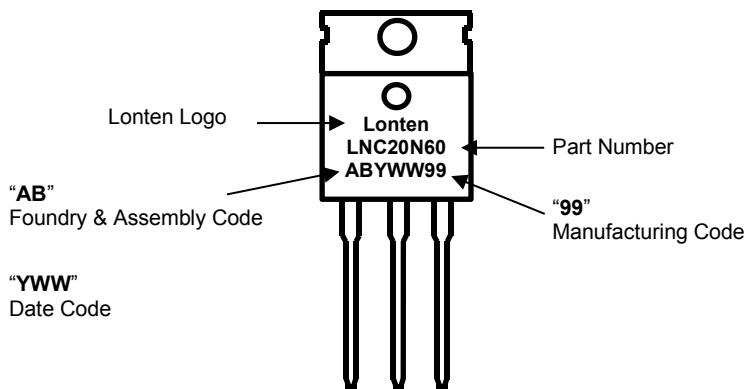


Mechanical Dimensions for TO-220

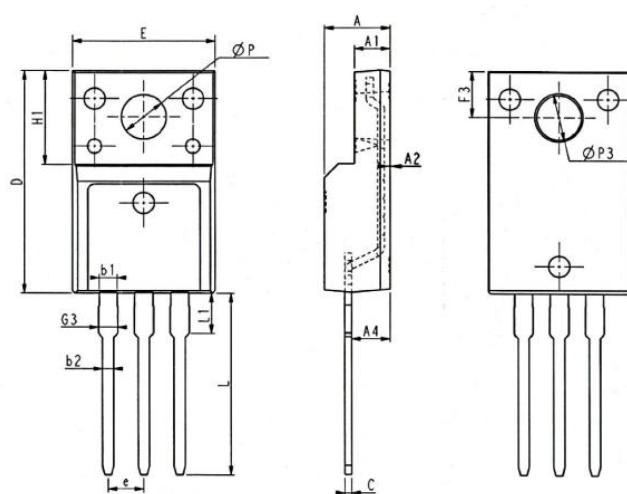


SYMBOL	COMMON DIMENSIONS					
	MM	NOM	MAX	MIN	NOM	MAX
A	4.37	4.57	4.70	0.172	0.180	0.185
A1	1.25	1.30	1.40	0.049	0.051	0.055
A2	2.20	2.40	2.60	0.087	0.094	0.102
b	0.70	0.80	0.95	0.028	0.031	0.037
b2	1.17	1.27	1.47	0.046	0.050	0.058
c	0.45	0.50	0.60	0.018	0.020	0.024
D	15.10	15.60	16.10	0.594	0.614	0.634
D1	8.80	9.10	9.40	0.346	0.358	0.370
D2	5.50	—	—	0.217	—	—
E	9.70	10.00	10.30	0.382	0.394	0.406
E3	7.00	—	—	0.276	—	—
e	2.54BSC			0.1BSC		
e1	5.08BSC			0.2BSC		
H1	6.25	6.50	6.85	0.246	0.256	0.270
L	12.75	13.50	13.80	0.502	0.531	0.543
L1	—	3.10	3.40	—	0.122	0.134
Øp	3.40	3.60	3.80	0.134	0.142	0.150
Q	2.60	2.80	3.00	0.102	0.110	0.118

TO-220 Part Marking Information

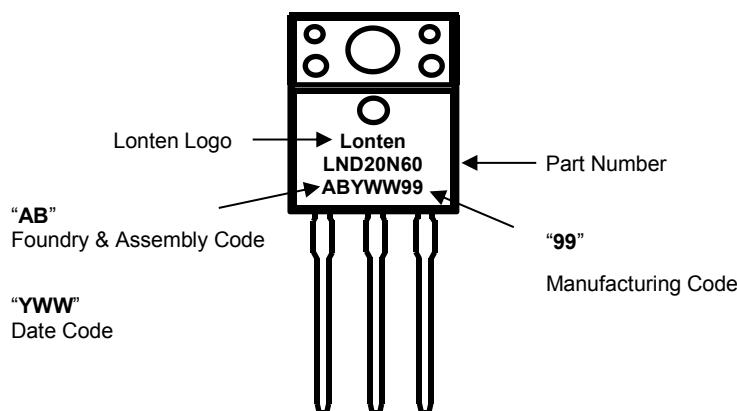


Mechanical Dimensions for TO-220F

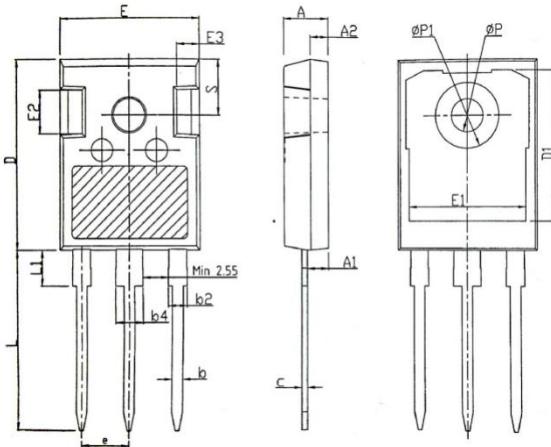


SYMBOL	COMMON DIMENSIONS			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
E	9.96	10.16	10.36	0.392	0.400	0.408
A	4.50	4.70	4.90	0.177	0.185	0.193
A1	2.34	2.54	2.74	0.092	0.100	0.108
A2	0.30	0.45	0.60	0.012	0.002	0.024
A4	2.65	2.76	2.96	0.104	0.109	0.117
C	0.40	0.50	0.65	0.016	0.020	0.026
D	15.57	15.87	16.17	0.613	0.625	0.637
H1	6.70REF			0.264REF		
e	2.54BSC			0.1BSC		
ØP	3.03	3.18	3.38	0.119	0.125	0.133
L	12.68	12.98	13.28	0.499	0.511	0.523
L1	2.88	3.03	3.18	0.113	0.119	0.125
ØP3	3.15REF			0.124REF		
F3	3.15	3.30	3.45	0.124	0.130	0.136
G3	1.25	1.35	1.55	0.049	0.053	0.061
b1	1.18	1.28	1.43	0.046	0.050	0.056
b2	0.70	0.80	0.95	0.028	0.031	0.037

TO-220F Part Marking Information

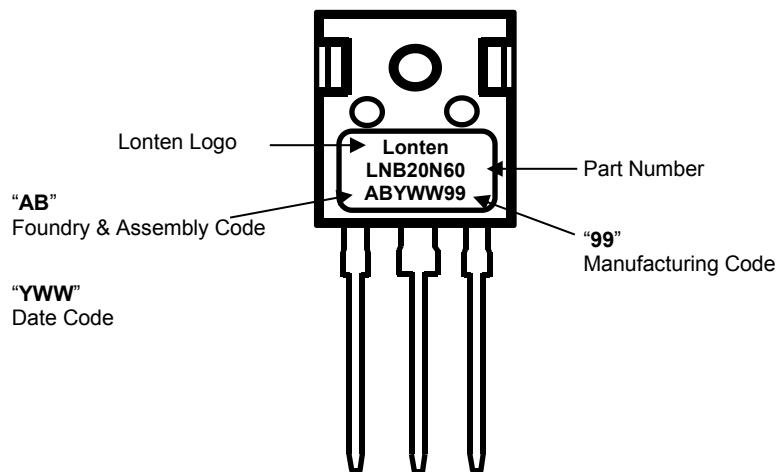


Mechanical Dimensions for TO-247

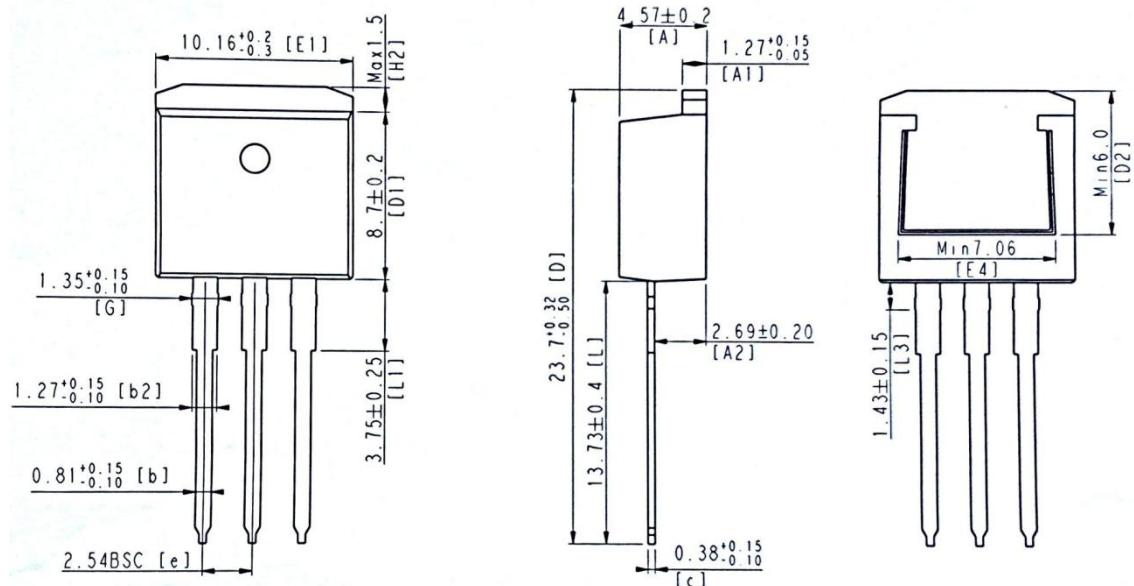


SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.80	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.82	19.92	20.22
L1	—	—	4.30
ØP	3.40	3.60	3.80
ØP1	—	—	7.30
S	6.15BSC		

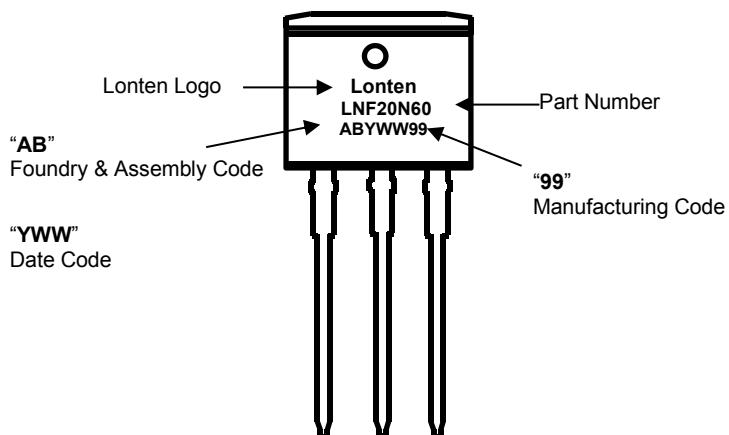
TO-247 Part Marking Information



Mechanical Dimensions for TO-262



TO-262 Part Marking Information



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